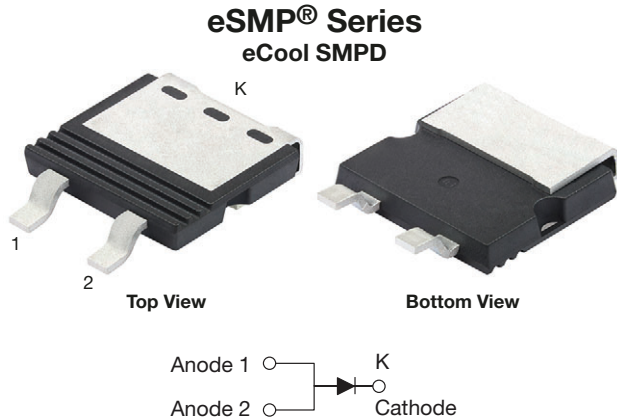


High-Voltage TMBS[®] (Trench MOS Barrier Schottky) Rectifier

 Ultra Low $V_F = 0.39\text{ V}$ at $I_F = 5.0\text{ A}$


LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS	
$I_{F(AV)}$	40 A
V_{RRM}	120 V
I_{FSM}	500 A
V_F at $I_F = 40\text{ A}$ ($T_J = 125\text{ °C}$)	0.67 V
T_J max.	150 °C
Package	eCool SMPD
Circuit configuration	Single

FEATURES

- Top side cool
- Trench MOS Schottky technology
- Ideal for automated placement
- Low forward voltage drop, low power losses
- High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available:
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912


RoHS
COMPLIANT
HALOGEN
FREE

TYPICAL APPLICATIONS

For use in high frequency DC/DC converters, switching power supplies, freewheeling diodes, OR-ing diode, and reverse battery protection in commercial, industrial, and automotive application.

MECHANICAL DATA

Case: eCool SMPD

Molding compound meets UL 94 V-0 flammability rating
 Base P/N-M3 - halogen-free, RoHS-compliant
 Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: as marked

MAXIMUM RATINGS ($T_A = 25\text{ °C}$ unless otherwise noted)			
PARAMETER	SYMBOL	V40C120	UNIT
Device marking code		V40C120	
Maximum repetitive peak reverse voltage	V_{RRM}	120	V
Maximum average forward rectified current (fig. 1)	$I_F^{(1)}$	40	A
	$I_F^{(2)}$	9.2	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I_{FSM}	500	A
Operating junction temperature range	$T_J^{(3)}$	-40 to +150	°C
Storage temperature range	T_{STG}	-55 to +150	

Notes

- (1) Mounted on infinite heatsink
- (2) Free air, mounted on FR4 PCB. 2 oz., standard footprint with top side aluminum cooling
- (3) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



ELECTRICAL CHARACTERISTICS (T _J = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Instantaneous forward voltage per diode	I _F = 5 A	T _J = 25 °C	V _F ⁽¹⁾	0.48	-	V
	I _F = 20 A			0.66	-	
	I _F = 40 A			0.84	0.90	
	I _F = 5 A	T _J = 125 °C		0.39	-	
	I _F = 20 A			0.56	-	
	I _F = 40 A			0.67	0.72	
Reverse current at rated V _R per diode	V _R = 90 V	T _J = 25 °C	I _R ⁽²⁾	0.005	-	mA
		T _J = 125 °C		5	-	
	V _R = 120 V	T _J = 25 °C		-	0.95	
		T _J = 125 °C		10	35	
Typical junction capacitance	4.0 V, 1 MHz		C _J	2950	-	pF

Notes

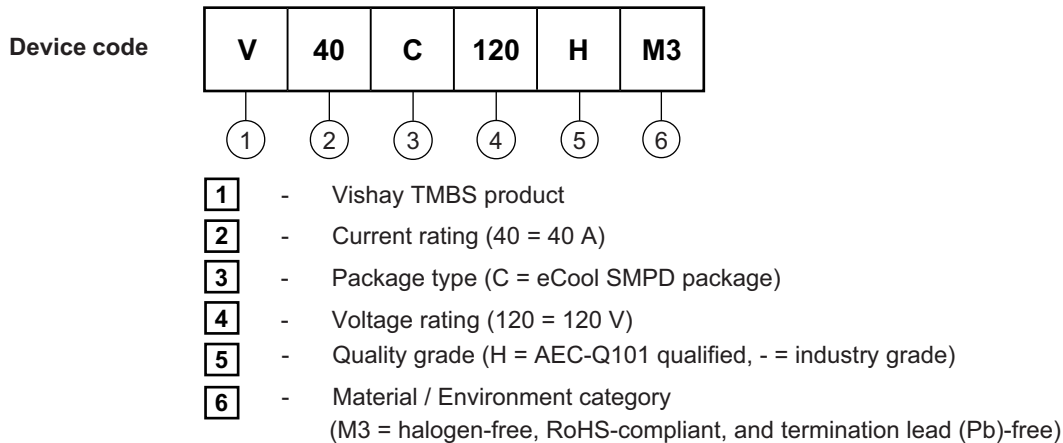
- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
- (2) Pulse test: Pulse width ≤ 5 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Typical thermal resistance per device	R _{θJC} ⁽¹⁾⁽²⁾	26.5	34	°C/W
	R _{θJA} ⁽³⁾	0.8	1.0	

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: dP_D/dT_J < 1/R_{θJA} - junction-to-ambient
- (2) Thermal resistance junction-to-ambient to follow JEDEC® 51-2A, device mounted on FR4 PCB, 2 oz. standard footprint with top-side aluminum cooling heatsink size L 35 mm x W 20 mm x H 10 mm
- (3) Thermal resistance junction-to-top case to follow JEDEC® 51-14 transient dual interface test method (TDIM)

ORDERING INFORMATION TABLE



ORDERING INFORMATION (Example)				
PREFERRED P/N	UNIT WEIGHT (g)	PACKAGE CODE	BASE QUANTITY	DELIVERY MODE
V40C120-M3/I	0.66	I	2000/reel	13" diameter plastic tape and reel
V40C120HM3/I ⁽¹⁾	0.66	I	2000/reel	13" diameter plastic tape and reel

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

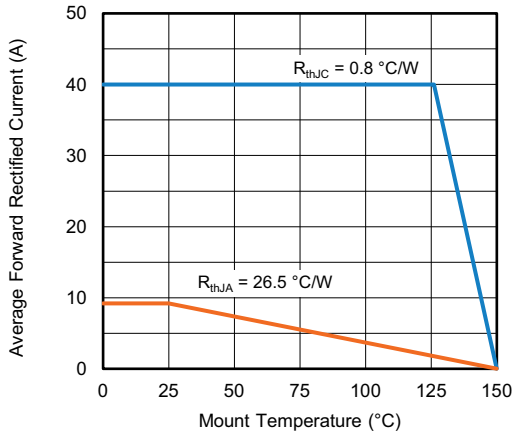


Fig. 1 - Maximum Forward Current Derating Curve

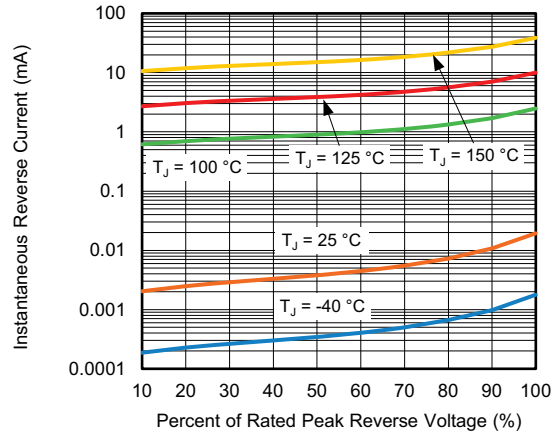


Fig. 4 - Typical Reverse Leakage Characteristics

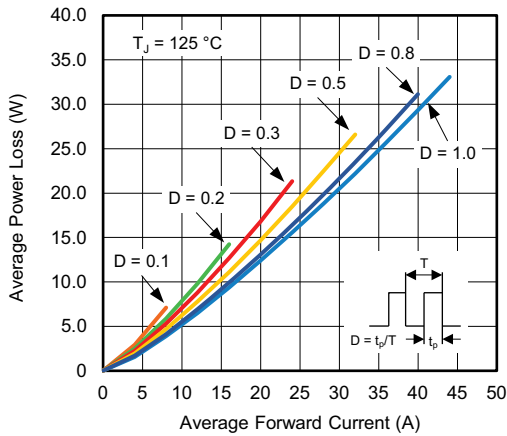


Fig. 2 - Average Power Loss Characteristics

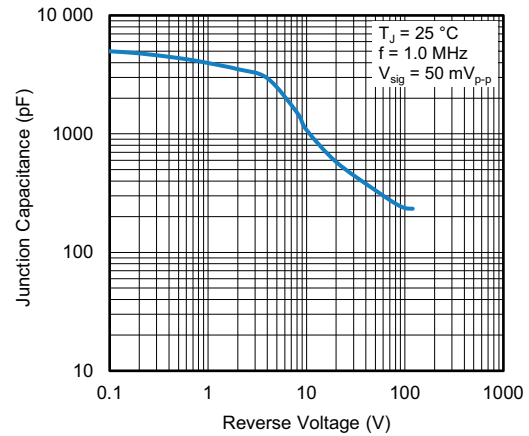


Fig. 5 - Typical Junction Capacitance

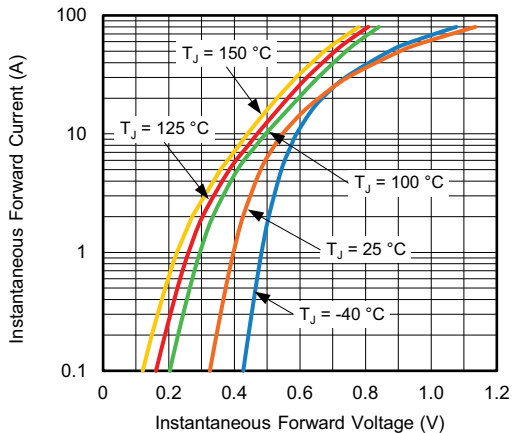


Fig. 3 - Typical Instantaneous Forward Characteristics

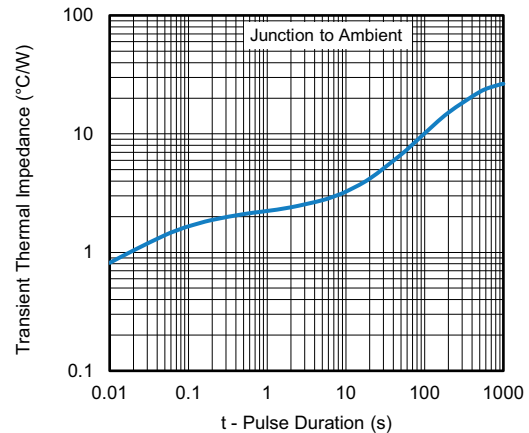
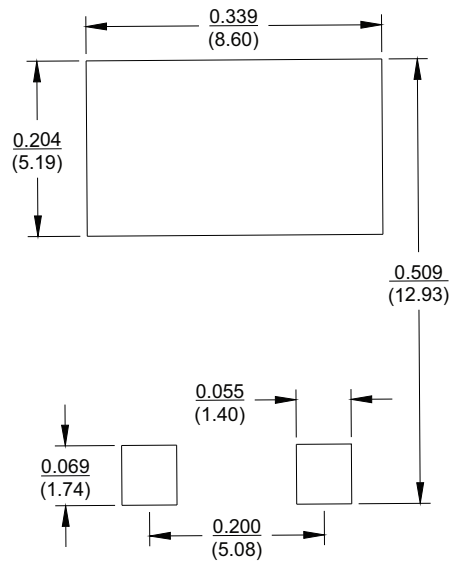
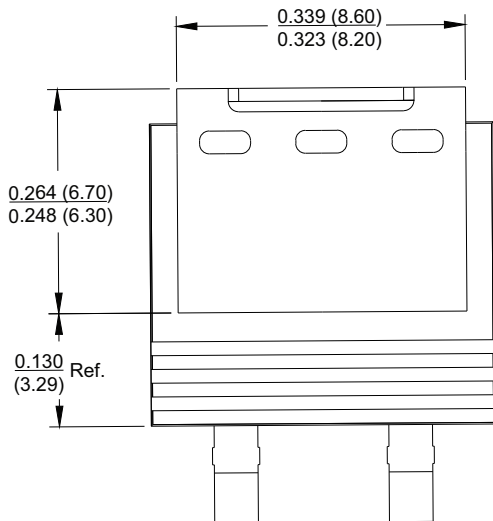
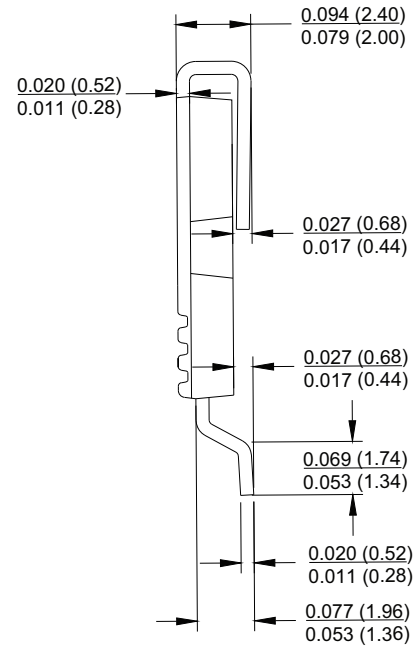
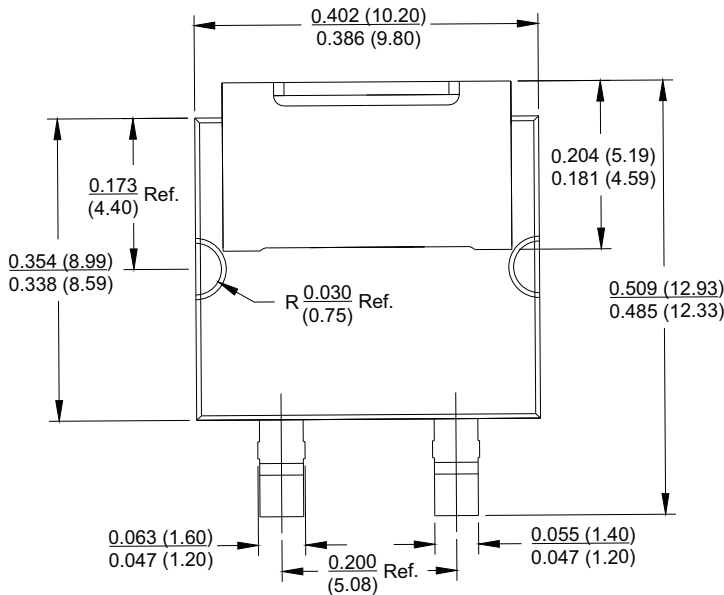


Fig. 6 - Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS in inches (millimeters)

eCool SMPD



Note

- The suggested mounting pad layout is provided for reference only, as actual pad layouts may vary depending on application



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